MOSFET – Power, Single, N-Channel, SO-8 FL 30 V, 246 A

Features

- Low R_{DS(on)} to Improve Conduction and Overall Efficiency
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- OR-ing FET, Power Load Switch, Motor Control
- Refer to Application Note AND8195/D for Mounting Information

End Products

Motor Control, UPS, Fault-Tolerant Power Systems, Hot Swap
 MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

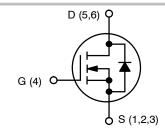
Para	meter		Symbol	Value	Unit
Drain-to-Source Volt	Drain-to-Source Voltage		V _{DSS}	30	V
Gate-to-Source Volta	age		V _{GS}	±20	V
Continuous Drain Current R _{B.IA}		T _A = 25°C	I _D	40	Α
(Note 1)		T _A = 100°C		25	
Power Dissipation R _{θJA} (Note 1)		T _A = 25°C	P _D	2.74	W
Continuous Drain Current $R_{\theta JA} \le 10 \text{ s}$		T _A = 25°C	I _D	77	Α
(Note 1)		T _A = 100°C		48	
Power Dissipation $R_{\theta JA} \le 10 \text{ s (Note 1)}$	Steady	T _A = 25°C	P _D	10.2	W
Continuous Drain	State	T _A = 25°C	I _D	23	Α
Current R _{θJA} (Note 2)		T _A = 100°C		15	
Power Dissipation R _{θJA} (Note 2)		T _A = 25°C	P _D	0.95	W
Continuous Drain		T _C = 25°C	I _D	246	Α
Current R _{θJC} (Note 1)		T _C =100°C		156	
Power Dissipation R _{0JC} (Note 1)		T _C = 25°C	P _D	104	W
Pulsed Drain Current	$T_A = 25^{\circ}$	°C, t _p = 10 μs	I _{DM}	490	Α
Operating Junction and Storage Temperature		T _J , T _{STG}	-55 to +150	°C	
Source Current (Body	Source Current (Body Diode)		I _S	100	Α
Drain to Source DV/DT		dV/d _t	4.4	V/ns	



ON Semiconductor®

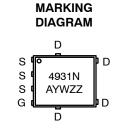
www.onsemi.com

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	1.1 mΩ @ 10 V	246 A
30 V	1.5 mΩ @ 4.5 V	240 A



N-CHANNEL MOSFET





A = Assembly Location
Y = Year
W = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4931NT1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel
NTMFS4931NT3G	SO-8 FL (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise stated)

Parameter	Symbol	Value	Unit
Single Pulse Drain-to-Source Avalanche Energy (T_J = 25°C, V_{DD} = 24 V, V_{GS} = 10 V, I_L = 41 A_{pk} , L = 0.3 mH, R_G = 25 Ω)	E _{AS}	252	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	TL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface—mounted on FR4 board using 1 sq-in pad, 1 oz Cu.

2. Surface—mounted on FR4 board using the minimum recommended pad size.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{ heta JC}$	1.2	
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	45.7	°C/W
Junction-to-Ambient - Steady State (Note 4)	$R_{\theta JA}$	132	*C/VV
Junction-to-Ambient – (t ≤ 10 s) (Note 3)	$R_{\theta JA}$	12.3	

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•				•	•	•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /				18		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25°C			1.0	μΑ
		V _{DS} = 24 V	T _J = 125°C			15	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{G}$	_S = ±20 V			±100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D}$	= 250 μΑ	1.2	1.6	2.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A		0.85	1.1	mΩ
			I _D = 15 A		0.82		
		V _{GS} = 4.5 V	I _D = 30 A		1.2	1.5	
			I _D = 15 A		1.2		1
Forward Transconductance	9FS	V _{DS} = 1.5 V, I _D = 15 A			86		S
CHARGES, CAPACITANCES & GATE RESIS	TANCE						
Input Capacitance	C _{ISS}				9821		pF
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MH	Hz, V _{DS} = 15 V		2720		
Reverse Transfer Capacitance	C _{RSS}				234		
Total Gate Charge	Q _{G(TOT)}				61.5		
Threshold Gate Charge	Q _{G(TH)}		45.77.1 00.4		14.2		1
Gate-to-Source Charge	Q_{GS}	$V_{GS} = 4.5 \text{ V}, V_{DS} = 15 \text{ V}; I_D = 30 \text{ A}$			25.2		nC
Gate-to-Drain Charge	Q_{GD}				15.9		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 15 V; I _D = 30 A			128		nC
SWITCHING CHARACTERISTICS (Note 6)					•		
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 15 V, I_{D} = 15 A, R_{G} = 3.0 Ω			27		
Rise Time	t _r				29		1
Turn-Off Delay Time	t _{d(OFF)}				36		ns
Fall Time	t _f				24		1

Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
 Surface-mounted on FR4 board using the minimum recommended pad size.

^{5.} Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$.
6. Switching characteristics are independent of operating junction temperatures.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

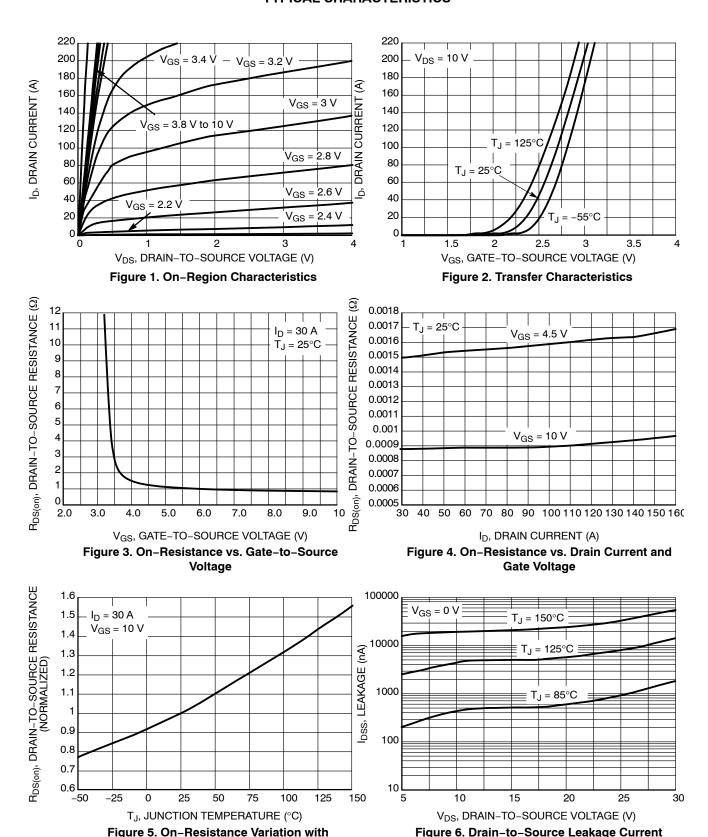
Parameter	dition	Min	Тур	Max	Unit		
SWITCHING CHARACTERISTICS (N	Symbol ote 6)	rest con			Typ	WILL	Oilit
·	· ·			Ī	15		
Turn-On Delay Time	t _{d(ON)}						ns
Rise Time	t _r	$V_{GS} = 10 \text{ V}, \text{ V}_{D}$	_{DS} = 15 V,		17		
Turn-Off Delay Time	t _{d(OFF)}	$I_D = 15 A, R_C$	$_{3}=3.0~\Omega$		80		
Fall Time	t _f	1			22		
DRAIN-SOURCE DIODE CHARACTI	ERISTICS						
Forward Diode Voltage	V_{SD}	VGS = 0 V,	T _J = 25°C		0.8	1.0	V
			T _J = 125°C		0.62		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/μs, I _S = 30 A			64		ns
Charge Time	t _a				33		
Discharge Time	t _b				31		
Reverse Recovery Charge	Q_{RR}				100		nC
PACKAGE PARASITIC VALUES							
Source Inductance	L _S				0.50		nH
Drain Inductance	L _D	T _A = 25°C			0.005		nH
Gate Inductance	L _G				1.84		nH
Gate Resistance	R_{G}				0.7	1.8	Ω

^{5.} Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%.

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{6.} Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



vs. Voltage

Temperature

TYPICAL CHARACTERISTICS

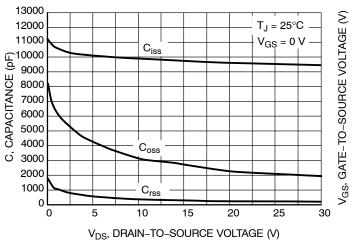


Figure 7. Capacitance Variation

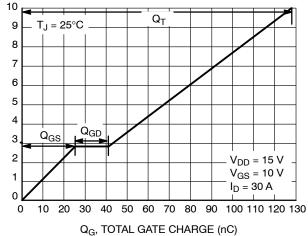


Figure 8. Gate-To-Source and Drain-To-Source Voltage vs. Total Charge

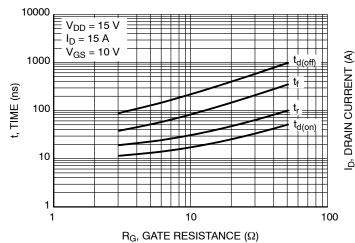


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

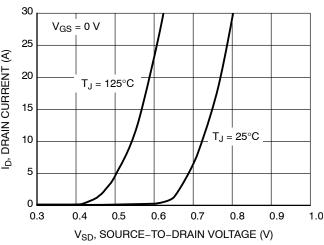


Figure 10. Diode Forward Voltage vs. Current

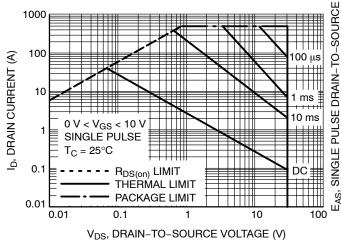


Figure 11. Maximum Rated Forward Biased Safe Operating Area

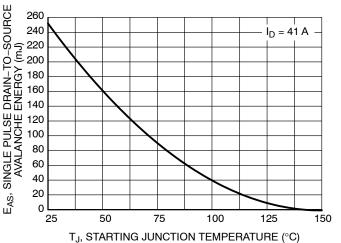


Figure 12. Maximum Avalanche Energy vs. Starting Junction Temperature

TYPICAL CHARACTERISTICS

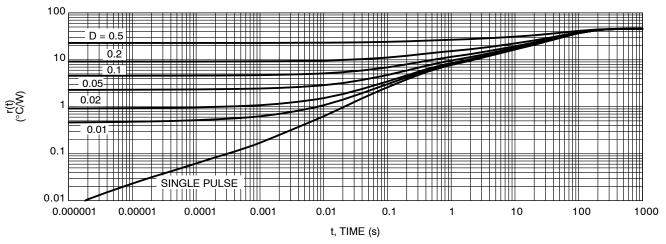


Figure 13. Thermal Response

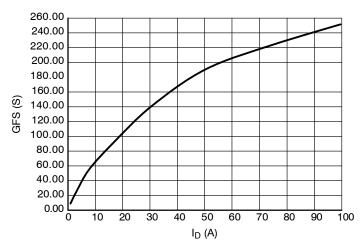
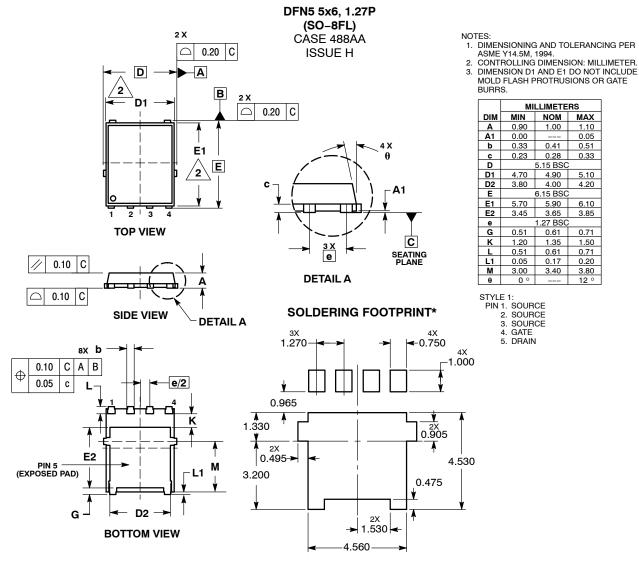


Figure 14. GFS vs. I_D

PACKAGE DIMENSIONS



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and 🕠 are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. coverage may be accessed at www.onsemi.com/site/pat/ratent-warring.pgr. On Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

MAX

1.10

0.05

0.51

0.33

4.20

3.85

0.71

0.71

0.20

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor:

NTMFS4931NT1G NTMFS4931NT3G